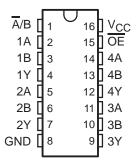
SN54HCT257, SN74HCT257 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

SCLS072D - NOVEMBER 1988 - REVISED SEPTEMBER 2003

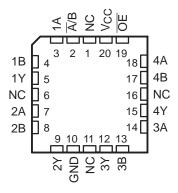
- Operating Voltage Range of 4.5 V to 5.5 V
- High-Current 3-State Outputs Interface Directly With System Bus
- Typical t_{pd} = 17 ns
- Low Power Consumption, 80-μA Max I_{CC}
- ±6-mA Output Drive at 5 V

SN54HCT257 . . . J PACKAGE SN74HCT257 . . . D OR N PACKAGE (TOP VIEW)



- Low Input Current of 1 μA Max
- Inputs Are TTL-Voltage Compatible
- Provide Bus Interface From Multiple Sources in High-Performance Systems
- Buffered Inputs and Outputs

SN54HCT257 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

description/ordering information

The 'HCT257 devices are designed to multiplex signals from 4-bit data sources to 4-output data lines in bus-organized systems. The 3-state outputs do not load the data lines when the output-enable (\overline{OE}) input is at the high logic level.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION

TA	PACKAC	3E†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube of 25	SN74HCT257N	SN74HCT257N
4000 4- 0500		Tube of 40	SN74HCT257D	
-40°C to 85°C	SOIC - D	Reel of 2500	SN74HCT257DR	HCT257
		Reel of 250	SN74HCT257DT	
5500 to 40500	CDIP – J	Tube of 25	SNJ54HCT257J	SNJ54HCT257J
–55°C to 125°C	LCCC - FK	Tube of 55	SNJ54HCT257FK	SNJ54HCT257FK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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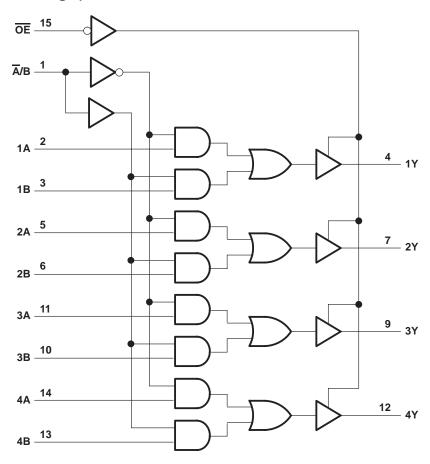


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FUNCTION TABLE

	INPU	ΓS		
ŌĒ	SELECT	DA	TA	OUTPUT
OE	A/B	Α	В	·
Н	Х	Х	Х	Z
L	L	L	X	L
L	L	Н	X	Н
L	Н	Χ	L	L
L	Н	Χ	Н	Н

logic diagram (positive logic)



Pin numbers shown are for the D, J, and N packages.



SN54HCT257, SN74HCT257 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±35 mA
Continuous current through V _{CC} or GND	±70 mA
Package thermal impedance, θ _{JA} (see Note 2): D package	
N package	
Storage temperature range, T _{Stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

			SN	54HCT2	57	SN	74HCT2	57	LINUT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	V _{CC} = 4.5 V to 5.5 V	2	Į.	7/	2			V
VIL	Low-level input voltage	V _{CC} = 4.5 V to 5.5 V		77	0.8			0.8	V
VI	Input voltage		0	1	VCC	0		VCC	V
VO	Output voltage		0	2	Vcc	0		VCC	V
t _t	Input transition (rise and fall) time		000	5	500			500	ns
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

24244555	7507.00	NETIONS	.,	Т	A = 25°C	;	SN54H	CT257	SN74HCT257		
PARAMETER	TEST CO	NDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
V	No. No. and	$I_{OH} = -20 \mu A$	45.1/	4.4	4.499		4.4		4.4		
VOH	VI = VIH or VIL	$I_{OH} = -6 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		٧
, ,	\ \ \\ an\\	I _{OL} = 20 μA	45.1/		0.001	0.1		0.1		0.1	V
VOL	$V_I = V_{IH}$ or V_{IL}	I _{OL} = 6 mA	4.5 V		0.17	0.26		0.4		0.33	V
lį	$V_I = V_{CC}$ or 0		5.5 V		±0.1	±100		±1000		±1000	nA
loz	$V_O = V_{CC}$ or 0,	$V_I = V_{IH}$ or V_{IL}	5.5 V		±0.01	±0.5	4	±10		±5	μΑ
Icc	$V_I = V_{CC}$ or 0,	I _O = 0	5.5 V			8	37/	160		80	μΑ
∆I _{CC} ‡	One input at 0.5 V Other inputs at 0 or		5.5 V		1.4	2.4	PRO	3		2.9	mA
Ci			4.5 V to 5.5 V		3	10		10*		10	pF

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

[‡]This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V_{CC}.

SN54HCT257, SN74HCT257 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

	FROM	то	1 Vaa -		λ = 25°C	;	SN54H	CT257	SN74H	CT257	
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	A or D	V	4.5 V		20	30		45		38	
	A or B	Y	5.5 V		17	27		40		34	
^t pd	Ā/B	V	4.5 V		20	30		45		38	ns
	A/B	Y	5.5 V		17	27		40		34	
	ŌĒ		4.5 V		20	30		45		38	
^t en	OE	Y	5.5 V		17	27	(0)	40		34	ns
	ŌĒ	Y	4.5 V		20	30	$g_{Q_{\zeta}}$	45		38	
^t dis	OE	Y	5.5 V		17	27) Y _G	40		34	ns
4.		Any	4.5 V	·	8	15		22		19	20
t _t		Any	5.5 V		7	14		21		17	ns

switching characteristics over recommended operating free-air temperature range, C_L = 150 pF (unless otherwise noted) (see Figure 1)

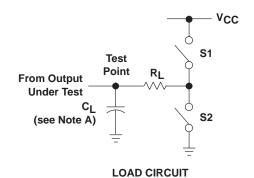
	FROM	то	.,	T,	λ = 25°C	;	SN54HCT257	SN74HCT257	
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN MAX	MIN MAX	UNIT
	A D	V	4.5 V		22	38	57	48	
	A or B	Y	5.5 V		19	35	53	44	
^t pd	Ā/B	V	4.5 V		22	38	57	48	ns
	A/B	Y	5.5 V		19	35	53	44	
	ŌĒ	V	4.5 V		23	40	5 60	50	
^t en	OE .	Y	5.5 V		20	38	57	48	ns
4.		Any	4.5 V		17	42	63	53	no
t _t		Any	5.5 V		14	38	57	48	ns

operating characteristics, T_A = 25°C

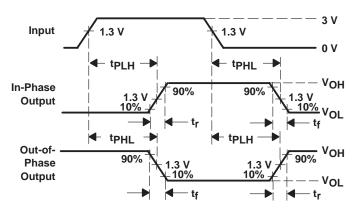
	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load	13	pF

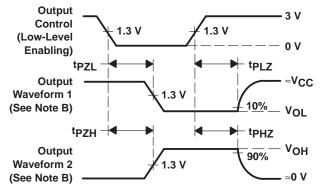
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PARAMETER MEASUREMENT INFORMATION



PARAM	/IETER	RL	CL	S1	S2
	tPZH		50 pF or	Open	Closed
t _{en}	tPZL	1 k Ω	150 pF	Closed	Open
4	tPHZ	1 k Ω	50 pF	Open	Closed
^t dis	tPLZ	1 K22	50 pr	Closed	Open
t _{pd} or	t _{pd} or t _t		50 pF or 150 pF	Open	Open





VOLTAGE WAVEFORMS
OUTPUT AND 3-STATE BIDIRECTIONAL I/O
PROPAGATION DELAY TIME

VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

NOTES: A. C_L includes probe and test-fixture capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 6 ns, t_f = 6 ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. tpl 7 and tpH7 are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74HCT257DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HCT257	Samples
SN74HCT257N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-40 to 85	SN74HCT257N	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION



TAPE DIMENSIONS + K0 - P1 - B0 W Cavity - A0 -

A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
ı	SN74HCT257DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Ì	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
ı	SN74HCT257DR	SOIC	D	16	2500	340.5	336.1	32.0

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74HCT257N	N	PDIP	16	25	506	13.97	11230	4.32
SN74HCT257N	N	PDIP	16	25	506	13.97	11230	4.32

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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